

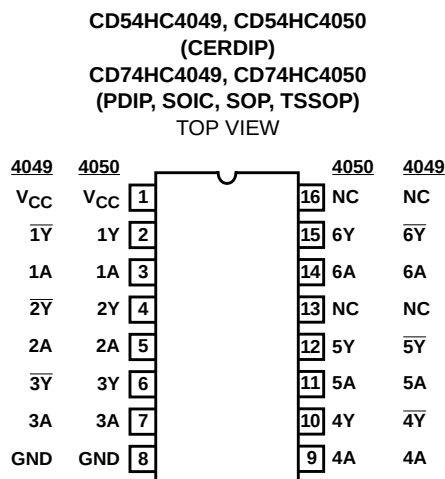
February 1998 - Revised February 2005

## High-Speed CMOS Logic Hex Buffers, Inverting and Non-Inverting

### Features

- Typical Propagation Delay: 6ns at  $V_{CC} = 5V$ ,  $C_L = 15pF$ ,  $T_A = 25^\circ C$
- High-to-Low Voltage Level Converter for up to  $V_I = 16V$
- Fanout (Over Temperature Range)
  - Standard Outputs . . . . . 10 LSTTL Loads
  - Bus Driver Outputs . . . . . 15 LSTTL Loads
- Wide Operating Temperature Range . . .  $-55^\circ C$  to  $125^\circ C$
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5V$

### Pinout



### Description

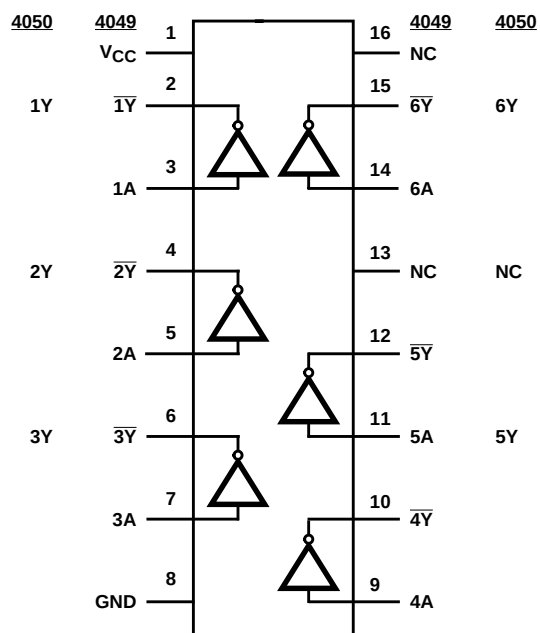
The 'HC4049 and 'HC4050 are fabricated with high-speed silicon gate technology. They have a modified input protection structure that enables these parts to be used as logic level translators which convert high-level logic to a low-level logic while operating off the low-level logic supply. For example, 15-V input pulse levels can be down-converted to 0-V to 5-V logic levels. The modified input protection structure protects the input from negative electrostatic discharge. These parts also can be used as simple buffers or inverters without level translation. The 'HC4049 and 'HC4050 are enhanced versions of equivalent CMOS types.

### Ordering Information

| PART NUMBER   | TEMP. RANGE<br>(°C) | PACKAGE      |
|---------------|---------------------|--------------|
| CD54HC4049F3A | -55 to 125          | 16 Ld CERDIP |
| CD54HC4050F3A | -55 to 125          | 16 Ld CERDIP |
| CD74HC4049E   | -55 to 125          | 16 Ld PDIP   |
| CD74HC4049M   | -55 to 125          | 16 Ld SOIC   |
| CD74HCT4050MT | -55 to 125          | 16 Ld SOIC   |
| CD74HC4049M96 | -55 to 125          | 16 Ld SOIC   |
| CD74HC4049NSR | -55 to 125          | 16 Ld SOP    |
| CD74HC4049PW  | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4049PWR | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4049PWT | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4050E   | -55 to 125          | 16 Ld PDIP   |
| CD74HC4050M   | -55 to 125          | 16 Ld SOIC   |
| CD74HC4050MT  | -55 to 125          | 16 Ld SOIC   |
| CD74HC4050M96 | -55 to 125          | 16 Ld SOIC   |
| CD74HC4050NSR | -55 to 125          | 16 Ld SOP    |
| CD74HC4050PW  | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4050PWR | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4050PWT | -55 to 125          | 16 Ld TSSOP  |

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

## Functional Diagram



## Logic Diagrams

HC4049



HC4050



# CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

## Absolute Maximum Ratings

|                                                        |              |
|--------------------------------------------------------|--------------|
| DC Supply Voltage, $V_{CC}$                            | −0.5V to 7V  |
| Input Voltage Range                                    | −0.5V to 16V |
| DC Input Diode Current, $I_{IK}$                       |              |
| For $V_I < -0.5V$                                      | −20mA        |
| DC Output Diode Current, $I_{OK}$                      |              |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$             | ±20mA        |
| DC Output Source or Sink Current per Output Pin, $I_O$ |              |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$             | ±25mA        |
| DC $V_{CC}$ or Ground Current, $I_{CC}$ or $I_{GND}$   | ±50mA        |

## Operating Conditions

|                                |                |
|--------------------------------|----------------|
| Temperature Range ( $T_A$ )    | −55°C to 125°C |
| Supply Voltage Range, $V_{CC}$ |                |
| HC Types                       | .2V to 6V      |
| HCT Types                      | 4.5V to 5.5V   |
| DC Input Voltage, $V_I$        | .0V to 15V     |
| DC Output Voltage, $V_O$       | 0V to $V_{CC}$ |
| Input Rise and Fall Time       |                |
| 2V                             | 1000ns (Max)   |
| 4.5V                           | 500ns (Max)    |
| 6V                             | 400ns (Max)    |

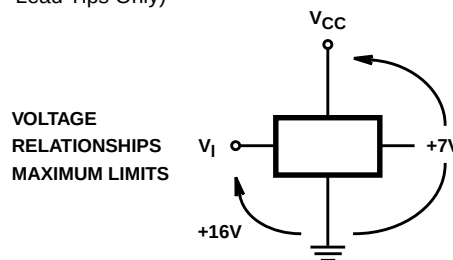
**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

## Thermal Information

|                                                        |                |
|--------------------------------------------------------|----------------|
| Package Thermal Impedance, $\theta_{JA}$ (see Note 1): |                |
| E (PDIP) Package                                       | 67°C/W         |
| M (SOIC) Package                                       | 73°C/W         |
| NS (SOP) Package                                       | 64°C/W         |
| PW (TSSOP) Package                                     | 108°C/W        |
| Maximum Junction Temperature (Hermetic Package or Die) | 175°C          |
| Maximum Junction Temperature (Plastic Package)         | 150°C          |
| Maximum Storage Temperature Range                      | −65°C to 150°C |
| Maximum Lead Temperature (Soldering 10s)               | 300°C          |
| (SOIC - Lead Tips Only)                                |                |



## DC Electrical Specifications

| PARAMETER                               | SYMBOL          | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |     |      | −40°C TO 85°C |      | −55°C TO 125°C |      | UNITS |
|-----------------------------------------|-----------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|------|-------|
|                                         |                 | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX  | MIN           | MAX  | MIN            | MAX  |       |
| HC TYPES                                |                 |                                    |                     |                     |      |     |      |               |      |                |      |       |
| High Level Input Voltage                | V <sub>IH</sub> | -                                  | -                   | 2                   | 1.5  | -   | -    | 1.5           | -    | 1.5            | -    | V     |
|                                         |                 |                                    |                     | 4.5                 | 3.15 | -   | -    | 3.15          | -    | 3.15           | -    | V     |
|                                         |                 |                                    |                     | 6                   | 4.2  | -   | -    | 4.2           | -    | 4.2            | -    | V     |
| Low Level Input Voltage                 | V <sub>IL</sub> | -                                  | -                   | 2                   | -    | -   | 0.5  | -             | 0.5  | -              | 0.5  | V     |
|                                         |                 |                                    |                     | 4.5                 | -    | -   | 1.35 | -             | 1.35 | -              | 1.35 | V     |
|                                         |                 |                                    |                     | 6                   | -    | -   | 1.8  | -             | 1.8  | -              | 1.8  | V     |
| High Level Output Voltage<br>CMOS Loads | V <sub>OH</sub> | V <sub>IH</sub> or V <sub>IL</sub> | −0.02               | 2                   | 1.9  | -   | -    | 1.9           | -    | 1.9            | -    | V     |
|                                         |                 |                                    | −0.02               | 4.5                 | 4.4  | -   | -    | 4.4           | -    | 4.4            | -    | V     |
|                                         |                 |                                    | −0.02               | 6                   | 5.9  | -   | -    | 5.9           | -    | 5.9            | -    | V     |
| High Level Output Voltage<br>TTL Loads  | V <sub>OH</sub> | V <sub>IH</sub> or V <sub>IL</sub> | −4                  | 4.5                 | 3.98 | -   | -    | 3.84          | -    | 3.7            | -    | V     |
|                                         |                 |                                    | −5.2                | 6                   | 5.48 | -   | -    | 5.34          | -    | 5.2            | -    | V     |
| Low Level Output Voltage<br>CMOS Loads  | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 2                   | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |
|                                         |                 |                                    | 0.02                | 4.5                 | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |
|                                         |                 |                                    | 0.02                | 6                   | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| Low Level Output Voltage<br>TTL Loads   | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 4                   | 4.5                 | -    | -   | 0.26 | -             | 0.33 | -              | 0.4  | V     |
|                                         |                 |                                    | 5.2                 | 6                   | -    | -   | 0.26 | -             | 0.33 | -              | 0.4  | V     |
| Input Leakage Current                   | I <sub>I</sub>  | V <sub>CC</sub> or GND             | -                   | 6                   | -    | -   | ±0.1 | -             | ±1   | -              | ±1   | μA    |
|                                         |                 | 15                                 | -                   | 6                   | -    | -   | ±0.5 | -             | ±5   | -              | ±5   |       |

# CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

## DC Electrical Specifications (Continued)

| PARAMETER                | SYMBOL          | TEST CONDITIONS        |                     | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|--------------------------|-----------------|------------------------|---------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|                          |                 | V <sub>I</sub> (V)     | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| Quiescent Device Current | I <sub>CC</sub> | V <sub>CC</sub> or GND | 0                   | 6                   | -    | -   | 2   | -             | 20  | -              | 40  | μA    |

## Switching Specifications Input t<sub>r</sub>, t<sub>f</sub> = 6ns

| PARAMETER                                                | SYMBOL                              | TEST<br>CONDITIONS    | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO<br>85°C |     | -55°C TO<br>125°C |     | UNITS |
|----------------------------------------------------------|-------------------------------------|-----------------------|---------------------|------|-----|-----|------------------|-----|-------------------|-----|-------|
|                                                          |                                     |                       |                     | MIN  | TYP | MAX | MIN              | MAX | MIN               | MAX |       |
| HC TYPES                                                 |                                     |                       |                     |      |     |     |                  |     |                   |     |       |
| Propagation Delay,<br>nA to nY HC4049<br>nA to nY HC4050 | t <sub>PLH</sub> , t <sub>PHL</sub> | C <sub>L</sub> = 50pF | 2                   | -    | -   | 85  | -                | 105 | -                 | 130 | ns    |
|                                                          |                                     |                       | 4.5                 | -    | -   | 17  | -                | 21  | -                 | 26  | ns    |
|                                                          |                                     |                       | 6                   | -    | -   | 14  | -                | 18  | -                 | 22  | ns    |
|                                                          |                                     | C <sub>L</sub> = 15pF | 5                   | -    | 6   | -   | -                | -   | -                 | -   | ns    |
| Transition Times (Figure 1)                              | t <sub>TLH</sub> , t <sub>THL</sub> | C <sub>L</sub> = 50pF | 2                   | -    | -   | 75  | -                | 95  | -                 | 110 | ns    |
|                                                          |                                     |                       | 4.5                 | -    | -   | 15  | -                | 19  | -                 | 22  | ns    |
|                                                          |                                     |                       | 6                   | -    | -   | 13  | -                | 16  | -                 | 19  | ns    |
| Input Capacitance                                        | C <sub>I</sub>                      | -                     | -                   | -    | -   | 10  | -                | 10  | -                 | 10  | pF    |
| Power Dissipation Capacitance<br>(Notes 2, 3)            | C <sub>PD</sub>                     | -                     | 5                   | -    | 35  | -   | -                | -   | -                 | -   | pF    |

### NOTES:

- C<sub>PD</sub> is used to determine the dynamic power consumption, per gate.
- P<sub>D</sub> = V<sub>CC</sub><sup>2</sup> f<sub>i</sub> (C<sub>PD</sub> + C<sub>L</sub>) where f<sub>i</sub> = Input Frequency, C<sub>L</sub> = Output Load Capacitance, V<sub>CC</sub> = Supply Voltage.

## Test Circuit and Waveform

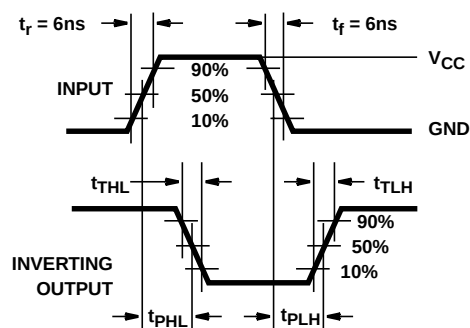


FIGURE 1. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)             |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------------------|
| <a href="#">5962-8681901EA</a> | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8681901EA<br>CD54HC4049F3A |
| <a href="#">5962-8682001EA</a> | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8682001EA<br>CD54HC4050F3A |
| <a href="#">CD54HC4049F3A</a>  | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8681901EA<br>CD54HC4049F3A |
| CD54HC4049F3A.A                | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8681901EA<br>CD54HC4049F3A |
| <a href="#">CD54HC4050F3A</a>  | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8682001EA<br>CD54HC4050F3A |
| CD54HC4050F3A.A                | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8682001EA<br>CD54HC4050F3A |
| <a href="#">CD74HC4049E</a>    | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC4049E                     |
| CD74HC4049E.A                  | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC4049E                     |
| CD74HC4049EE4                  | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC4049E                     |
| <a href="#">CD74HC4049M</a>    | Obsolete      | Production           | SOIC (D)   16   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HC4049M                         |
| <a href="#">CD74HC4049M96</a>  | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4049M                         |
| CD74HC4049M96.A                | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4049M                         |
| CD74HC4049M96G4                | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4049M                         |
| <a href="#">CD74HC4049MT</a>   | Obsolete      | Production           | SOIC (D)   16   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HC4049M                         |
| <a href="#">CD74HC4049NS</a>   | Obsolete      | Production           | SOP (NS)   16   | -                     | -           | Call TI                              | Call TI                           | -            | HC4049M                         |
| <a href="#">CD74HC4049NSR</a>  | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4049M                         |
| CD74HC4049NSR.A                | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4049M                         |
| <a href="#">CD74HC4049PW</a>   | Obsolete      | Production           | TSSOP (PW)   16 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HJ4049                          |
| <a href="#">CD74HC4049PWR</a>  | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HJ4049                          |
| CD74HC4049PWR.A                | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HJ4049                          |
| <a href="#">CD74HC4050E</a>    | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC4050E                     |
| CD74HC4050E.A                  | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC4050E                     |
| <a href="#">CD74HC4050M</a>    | Obsolete      | Production           | SOIC (D)   16   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HC4050M                         |
| <a href="#">CD74HC4050M96</a>  | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4050M                         |
| CD74HC4050M96.A                | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4050M                         |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CD74HC4050MT</a>  | Obsolete      | Production           | SOIC (D)   16   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HC4050M             |
| <a href="#">CD74HC4050NSR</a> | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4050M             |
| CD74HC4050NSR.A               | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC4050M             |
| <a href="#">CD74HC4050PW</a>  | Obsolete      | Production           | TSSOP (PW)   16 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HJ4050              |
| <a href="#">CD74HC4050PWR</a> | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HJ4050              |
| CD74HC4050PWR.A               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HJ4050              |
| CD74HC4050PWRG4               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HJ4050              |
| <a href="#">CD74HC4050PWT</a> | Obsolete      | Production           | TSSOP (PW)   16 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HJ4050              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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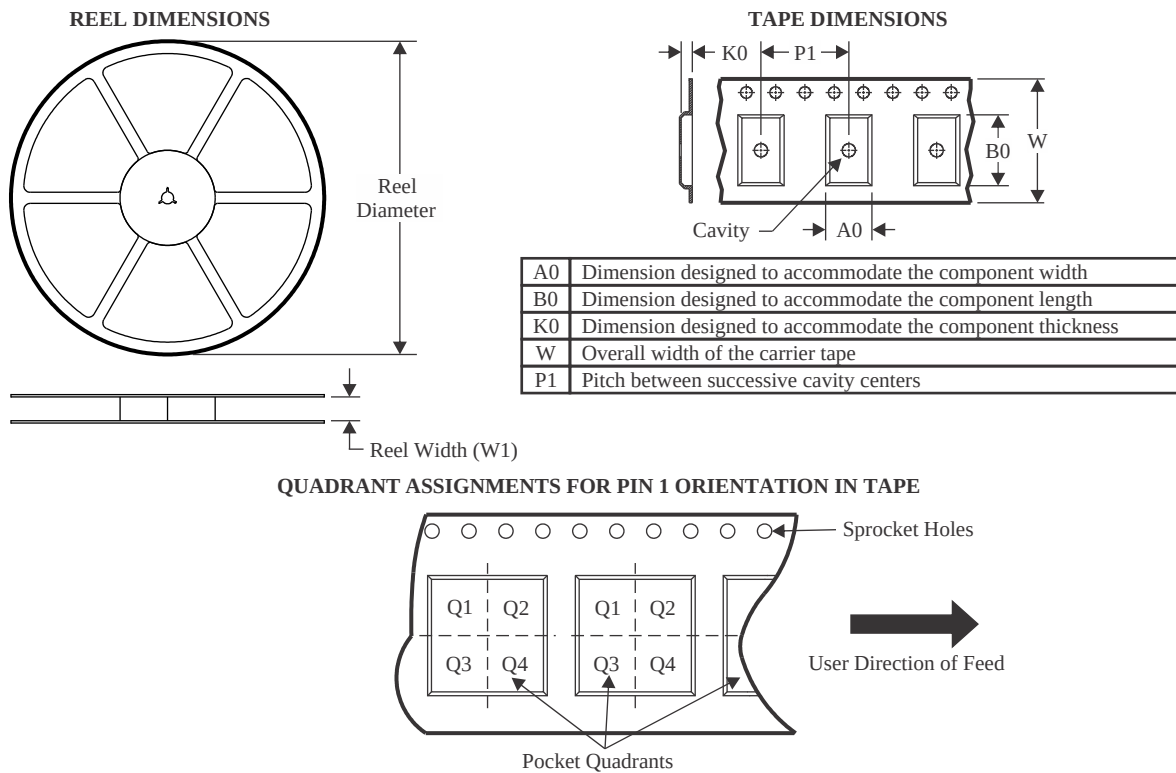
**OTHER QUALIFIED VERSIONS OF CD54HC4049, CD54HC4050, CD74HC4049, CD74HC4050 :**

- Catalog : [CD74HC4049](#), [CD74HC4050](#)
- Military : [CD54HC4049](#), [CD54HC4050](#)

## NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION

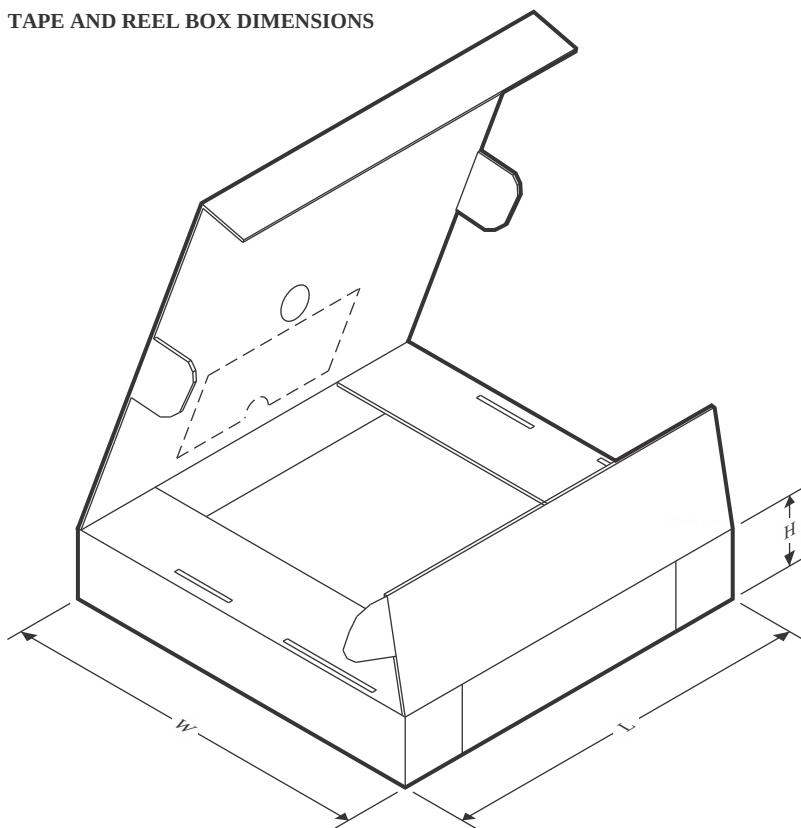


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74HC4049M96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD74HC4049NSR | SOP          | NS              | 16   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| CD74HC4049PWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| CD74HC4050M96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD74HC4050NSR | SOP          | NS              | 16   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| CD74HC4050PWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

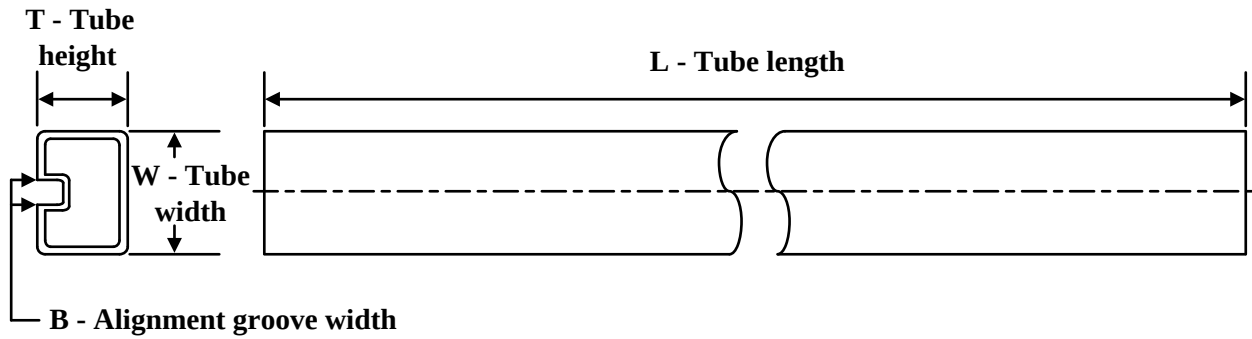


## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74HC4049M96 | SOIC         | D               | 16   | 2500 | 353.0       | 353.0      | 32.0        |
| CD74HC4049NSR | SOP          | NS              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD74HC4049PWR | TSSOP        | PW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD74HC4050M96 | SOIC         | D               | 16   | 2500 | 353.0       | 353.0      | 32.0        |
| CD74HC4050NSR | SOP          | NS              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD74HC4050PWR | TSSOP        | PW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |

**TUBE**


\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74HC4049E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4049E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4049E.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4049E.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4049EE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4049EE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4050E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4050E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4050E.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4050E.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |

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